

NOTICE OF
CANCELLATION

METRIC

MIL-F-14256F
NOTICE 1
June 15,1995

FLUX, SOLDERING, LIQUID, PASTE FLUX,
SOLDER PASTE AND SOLDER-PASTE FLUX,
(FOR ELECTRONIC/ELECTRICAL USE),
GENERAL SPECIFICATION FOR

MIL-F-14256F, dated 26 April 1993, and Amendment 1 dated 18 May 1994, are hereby canceled. Future acquisitions should refer to American National Standards J-STD-004, "Requirements for Soldering Fluxes"; J-STD-005, "Requirements for Soldering Pastes"; and J-STD-006, "Requirements for Electronic Grade Solder Alloys and Fluxed and Non-Fluxed Solid Solders for Electronic Soldering Applications", for flux and solder alloy materials.

(DoD activities may obtain copies of American National Standards J-STD-004, J-STD-005, and J-STD-006 from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094. The private sector and other Government agencies may purchase copies from the Institute for Interconnecting and Packaging Electronic Circuits (IPC), 7380 N. Lincoln Avenue, Lincolnwood, IL 60646.)

Custodians:
Army - ER
Navy - EC
Air Force - 99

Preparing activity:
Army - ER

Agent:
OSD - SO

(Project 3439-0866)

AMSC N/A

FSC 3439

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